

SS22 THRU SS210

Features

- Schottky Barrier Rectifier
- Guard Ring Protection
- Low Forward Voltage
- Reverse Energy Tested
- High Current Capability
- Extremely Low Thermal Resistance

Maximum Ratings

- Operating Temperature: -55°C to +125°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance; 15°C/W Junction To Lead

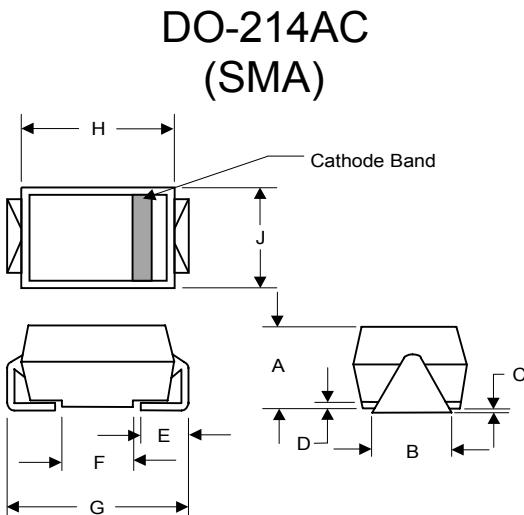
MCC Catalog Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
SS22	SS22	20V	14V	20V
SS23	SS23	30V	21V	30V
SS24	SS24	40V	28V	40V
SS25	SS25	50V	35V	50V
SS26	SS26	60V	42V	60V
SS28	SS28	80V	56V	80V
SS210	SS210	100V	70V	100V

Electrical Characteristics @ 25°C Unless Otherwise Specified

Average Forward Current	$I_{F(AV)}$	2.0A	$T_J = 100^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	50A	8.3ms, half sine
Maximum Instantaneous Forward Voltage SS22-SS24 SS25-SS26 SS28-SS210	V_F	.55V .70V .85V	$I_{FM} = 2.0\text{A};$ $T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	0.5mA	$T_J = 25^\circ\text{C}$
Typical Junction Capacitance SS22 SS23-SS210	C_J	230pF 50pF	Measured at 1.0MHz, $V_R=4.0\text{V}$

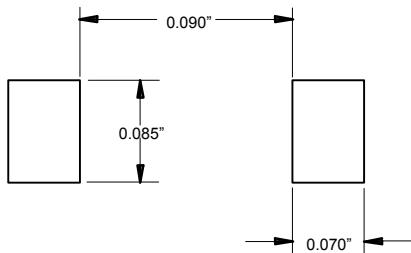
*Pulse test: Pulse width 300 μsec , Duty cycle 2%

2 Amp Schottky Rectifier 20 to 100 Volts



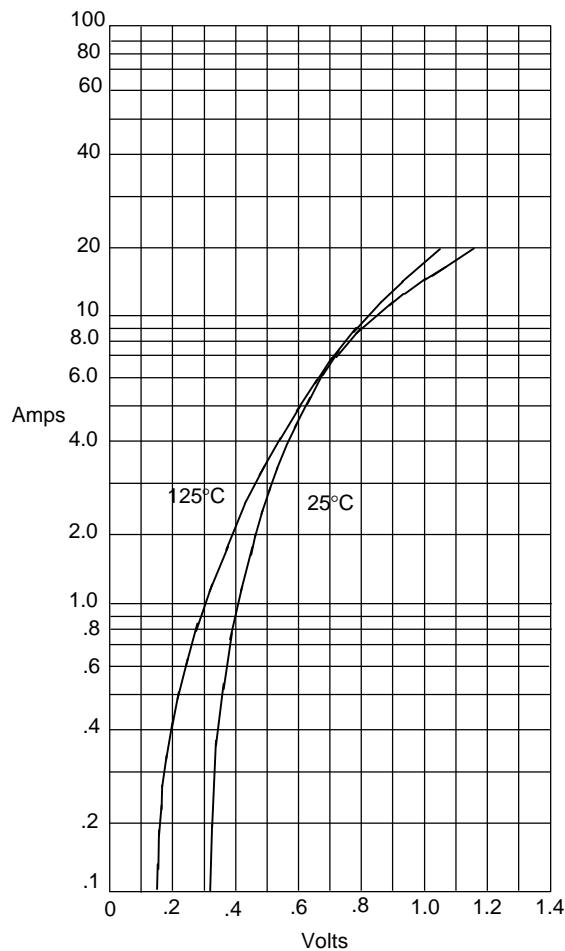
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.078	.116	1.98	2.95	
B	.067	.089	1.70	2.25	
C	.002	.008	.05	.20	
D	--	.02	--	.51	
E	.035	.055	.89	1.40	
F	.065	.096	1.65	2.45	
G	.205	.224	5.21	5.69	
H	.160	.180	4.06	4.57	
J	.100	.112	2.57	2.84	

SUGGESTED SOLDER PAD LAYOUT



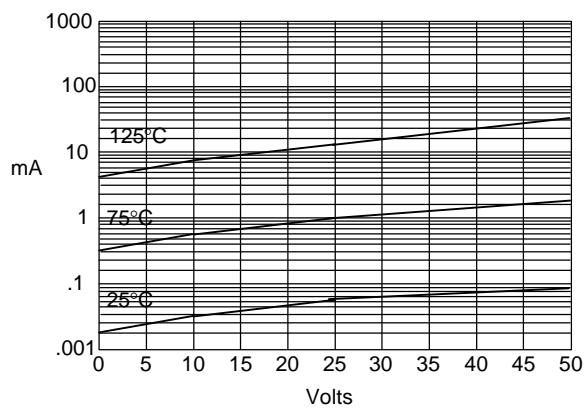
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Figure 1
Typical Forward Characteristics



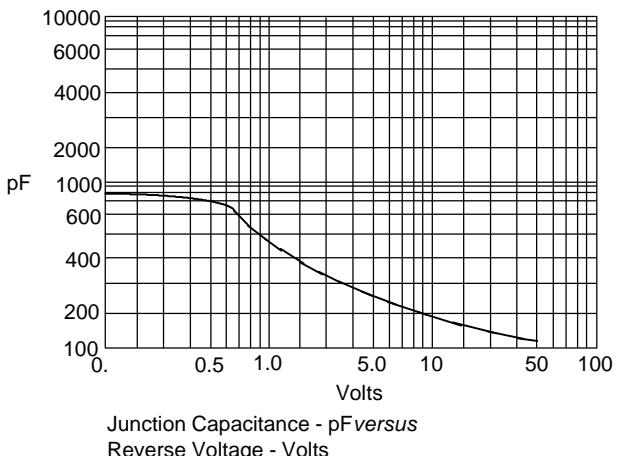
Instantaneous Forward Current - Amperesversus
Instantaneous Forward Voltage - Volts

Figure 2
Typical Reverse Characteristics



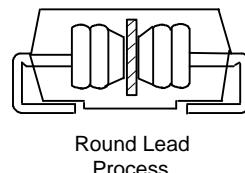
Typical Reverse Current - mAversus
Reverse Voltage - Volts

Figure 3
Typical Junction Capacitance



Junction Capacitance - pFversus
Reverse Voltage - Volts

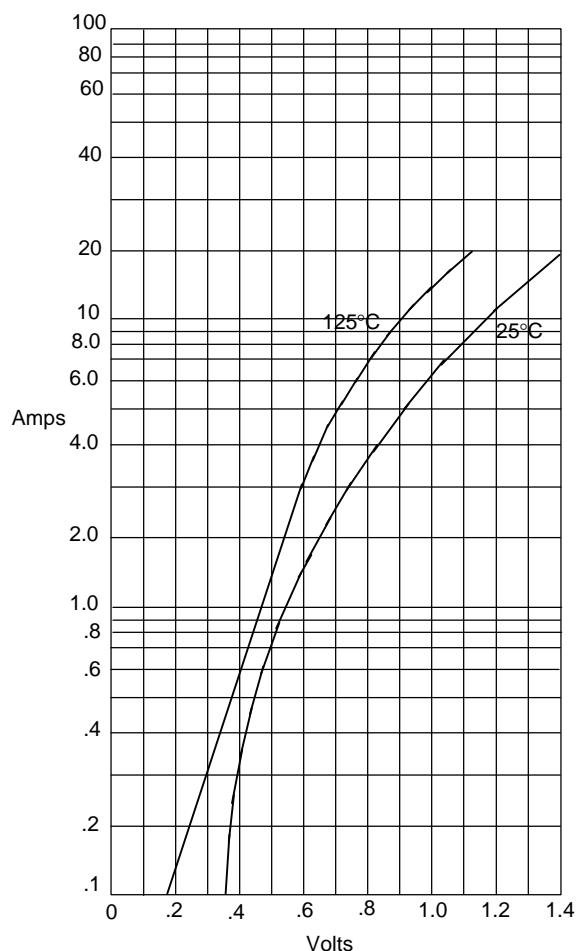
Figure 4
New SMA Assembly



Round Lead
Process

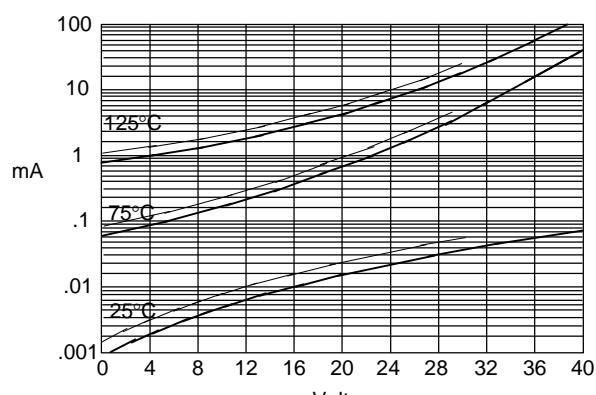
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Figure 1
Typical Forward Characteristics



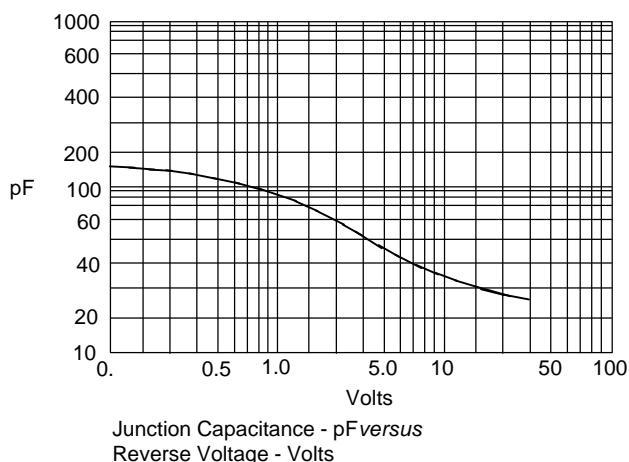
Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts

Figure 2
Typical Reverse Characteristics



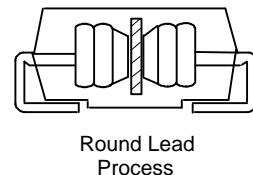
Typical Reverse Current - mA versus
Reverse Voltage - Volts

Figure 3
Typical Junction Capacitance



Junction Capacitance - pF versus
Reverse Voltage - Volts

Figure 4
New SMA Assembly



Round Lead
Process

SS23 _____
SS24 _____